

# SN54AHC245, SN74AHC245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS230I – OCTOBER 1995 – REVISED JULY 2003

- Operating Range 2-V to 5.5-V  $V_{CC}$
- Latch-Up Performance Exceeds 250 mA Per JESD 17

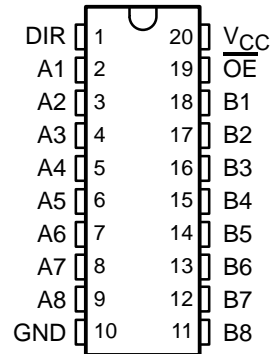
## description/ordering information

The 'AHC245 octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

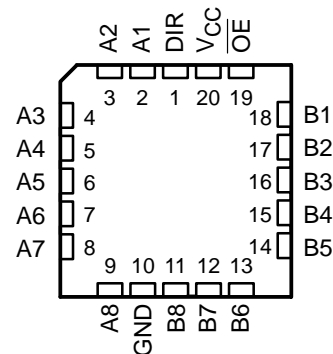
These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input can be used to disable the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## SN54AHC245 . . . J OR W PACKAGE SN74AHC245 . . . DB, DGV, DW, N, OR PW PACKAGE (TOP VIEW)



## SN54AHC245 . . . FK PACKAGE (TOP VIEW)



## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube	SN74AHC245N	AHC245
		Tape and reel	SN74AHC245DWR	
	SOIC – DW	Tube	SN74AHC245DW	HA245
		Tape and reel	SN74AHC245DWR	
	SSOP – DB	Tube	SN74AHC245DBR	HA245
		Tape and reel	SN74AHC245DBR	
-55°C to 125°C	TSSOP – PW	Tube	SN74AHC245PW	HA245
		Tape and reel	SN74AHC245PWR	
	TVSOP – DGV	Tube	SN74AHC245DGV	HA245
		Tape and reel	SN74AHC245DGV	
-55°C to 125°C	CDIP – J	Tube	SNJ54AHC245J	SNJ54AHC245J
	CFP – W	Tube	SNJ54AHC245W	SNJ54AHC245W
	LCCC – FK	Tube	SNJ54AHC245FK	SNJ54AHC245FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

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INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

[illegible]

Supply voltage range, $V_{CC}$	−0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1): Control inputs	−0.5 V to 7 V
I/O, Output voltage range, $V_O$ (see Note 1)	−0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ ): Control inputs	−20 mA
I/O, Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	±25 mA
Continuous current through $V_{CC}$ or GND	±75 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package	70°C/W
DGV package	92°C/W
DW package	58°C/W
N package	69°C/W
PW package	83°C/W

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The package thermal impedance is calculated in accordance with JEDEC 51-7.

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## recommended operating conditions (see Note 3)

			SN54AHC245		SN74AHC245		UNIT
			MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage		2	5.5	2	5.5	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2 V	1.5		1.5		V
		V <sub>CC</sub> = 3 V	2.1		2.1		
		V <sub>CC</sub> = 5.5 V	3.85		3.85		
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 2 V		0.5		0.5	V
		V <sub>CC</sub> = 3 V		0.9		0.9	
		V <sub>CC</sub> = 5.5 V		1.65		1.65	
V <sub>I</sub>	Input voltage	$\overline{\text{OE}}$ or DIR	0	5.5	0	5.5	V
V <sub>O</sub>	Output voltage	A or B	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2 V		–50		–50	μA
		V <sub>CC</sub> = 3.3 V ± 0.3 V		–4		–4	mA
		V <sub>CC</sub> = 5 V ± 0.5 V		–8		–8	
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2 V		50		50	μA
		V <sub>CC</sub> = 3.3 V ± 0.3 V		4		4	mA
		V <sub>CC</sub> = 5 V ± 0.5 V		8		8	
Δt/Δv	Input transition rise or fall rate	V <sub>CC</sub> = 3.3 V ± 0.3 V		100		100	ns/V
		V <sub>CC</sub> = 5 V ± 0.5 V		20		20	
T <sub>A</sub>	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54AHC245		SN74AHC245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>		I <sub>OH</sub> = –50 μA	2 V	1.9	2		1.9		1.9		V
			3 V	2.9	3		2.9		2.9		
			4.5 V	4.4	4.5		4.4		4.4		
		I <sub>OH</sub> = –4 mA	3 V	2.58			2.48		2.48		
			4.5 V	3.94			3.8		3.8		
V <sub>OL</sub>		I <sub>OL</sub> = 50 μA	2 V			0.1			0.1		V
			3 V			0.1			0.1		
			4.5 V			0.1			0.1		
		I <sub>OL</sub> = 4 mA	3 V			0.36			0.5		
			4.5 V			0.36			0.5		
I <sub>I</sub>	A or B inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.1			±1		μA
	$\overline{\text{OE}}$ or DIR		0 V to 5.5 V			±0.1			±1*		
I <sub>OZ</sub> <sup>†</sup>		V <sub>O</sub> = V <sub>CC</sub> or GND, V <sub>I</sub> ( $\overline{\text{OE}}$ ) = V <sub>IL</sub> or V <sub>IH</sub>	5.5 V			±0.25			±2.5		μA
I <sub>CC</sub>		V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V			4			40		μA
C <sub>i</sub>	$\overline{\text{OE}}$ or DIR	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V			2.5			10		pF
C <sub>io</sub>	A or B inputs	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V			4					pF

\* On products compliant to MIL-PRF-38535, this parameter is not production tested at V<sub>CC</sub> = 0 V.

† The parameter I<sub>OZ</sub> includes the input leakage current.



# SN54AHC245, SN74AHC245

## OCTAL BUS TRANSCEIVERS

### WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			SN54AHC245		SN74AHC245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	B or A	C <sub>L</sub> = 15 pF	5.8**	8.4**	1**	10**	1	10	ns	
t <sub>PHL</sub>				5.8**	8.4**	1**	10**	1	10		
t <sub>PZH</sub>	OE	A or B	C <sub>L</sub> = 15 pF	8.5**	13.2**	1**	15.5**	1	15.5	ns	
t <sub>PZL</sub>				8.5**	13.2**	1**	15.5**	1	15.5		
t <sub>PHZ</sub>	OE	A or B	C <sub>L</sub> = 15 pF	8.9**	12.5**	1**	15.5**	1	15.5	ns	
t <sub>PLZ</sub>				8.9**	12.5**	1**	15.5**	1	15.5		
t <sub>PLH</sub>	A or B	B or A	C <sub>L</sub> = 50 pF	8.3	11.9	1	13.5	1	13.5	ns	
t <sub>PHL</sub>				8.3	11.9	1	13.5	1	13.5		
t <sub>PZH</sub>	OE	A or B	C <sub>L</sub> = 50 pF	11	16.7	1	19	1	19	ns	
t <sub>PZL</sub>				11	16.7	1	19	1	19		
t <sub>PHZ</sub>	OE	A or B	C <sub>L</sub> = 50 pF	11.5	15.8	1	18	1	18	ns	
t <sub>PLZ</sub>				11.5	15.8	1	18	1	18		
t <sub>sk(o)</sub>			C <sub>L</sub> = 50 pF	1.5***				1.5		ns	

\*\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

\*\*\* On products compliant to MIL-PRF-38535, this parameter does not apply.

switching characteristics over recommended operating free-air temperature range,  
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T <sub>A</sub> = 25°C			SN54AHC245		SN74AHC245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	B or A	C <sub>L</sub> = 15 pF	4*	5.5*	1*	6.5*	1	6.5	ns	
t <sub>PHL</sub>				4*	5.5*	1*	6.5*	1	6.5		
t <sub>PZH</sub>	$\overline{OE}$	A or B	C <sub>L</sub> = 15 pF	5.8*	8.5*	1*	10*	1	10	ns	
t <sub>PZL</sub>				5.8*	8.5*	1*	10*	1	10		
t <sub>PHZ</sub>	$\overline{OE}$	A or B	C <sub>L</sub> = 15 pF	5.6*	7.8*	1*	9.2*	1	9.2	ns	
t <sub>PLZ</sub>				5.6*	7.8*	1*	9.2*	1	9.2		
t <sub>PLH</sub>	A or B	B or A	C <sub>L</sub> = 50 pF	5.5	7.5	1	8.5	1	8.5	ns	
t <sub>PHL</sub>				5.5	7.5	1	8.5	1	8.5		
t <sub>PZH</sub>	$\overline{OE}$	A or B	C <sub>L</sub> = 50 pF	7.3	10.6	1	12	1	12	ns	
t <sub>PZL</sub>				7.3	10.6	1	12	1	12		
t <sub>PHZ</sub>	$\overline{OE}$	A or B	C <sub>L</sub> = 50 pF	7	9.7	1	11	1	11	ns	
t <sub>PLZ</sub>				7	9.7	1	11	1	11		
t <sub>sk(o)</sub>			C <sub>L</sub> = 50 pF		1**				1	ns	

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

\*\* On products compliant to MIL-PRF-38535, this parameter does not apply.

**SN54AHC245, SN74AHC245**  
**OCTAL BUS TRANSCEIVERS**  
**WITH 3-STATE OUTPUTS**

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**noise characteristics,  $V_{CC} = 5\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$  (see Note 4)**

PARAMETER	SN74AHC245			UNIT
	MIN	TYP	MAX	
$V_{OL(P)}$ Quiet output, maximum dynamic $V_{OL}$		0.9		V
$V_{OL(V)}$ Quiet output, minimum dynamic $V_{OL}$		–0.9		V
$V_{OH(V)}$ Quiet output, minimum dynamic $V_{OH}$		4.3		V
$V_{IH(D)}$ High-level dynamic input voltage		3.5		V
$V_{IL(D)}$ Low-level dynamic input voltage			1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

**operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$**

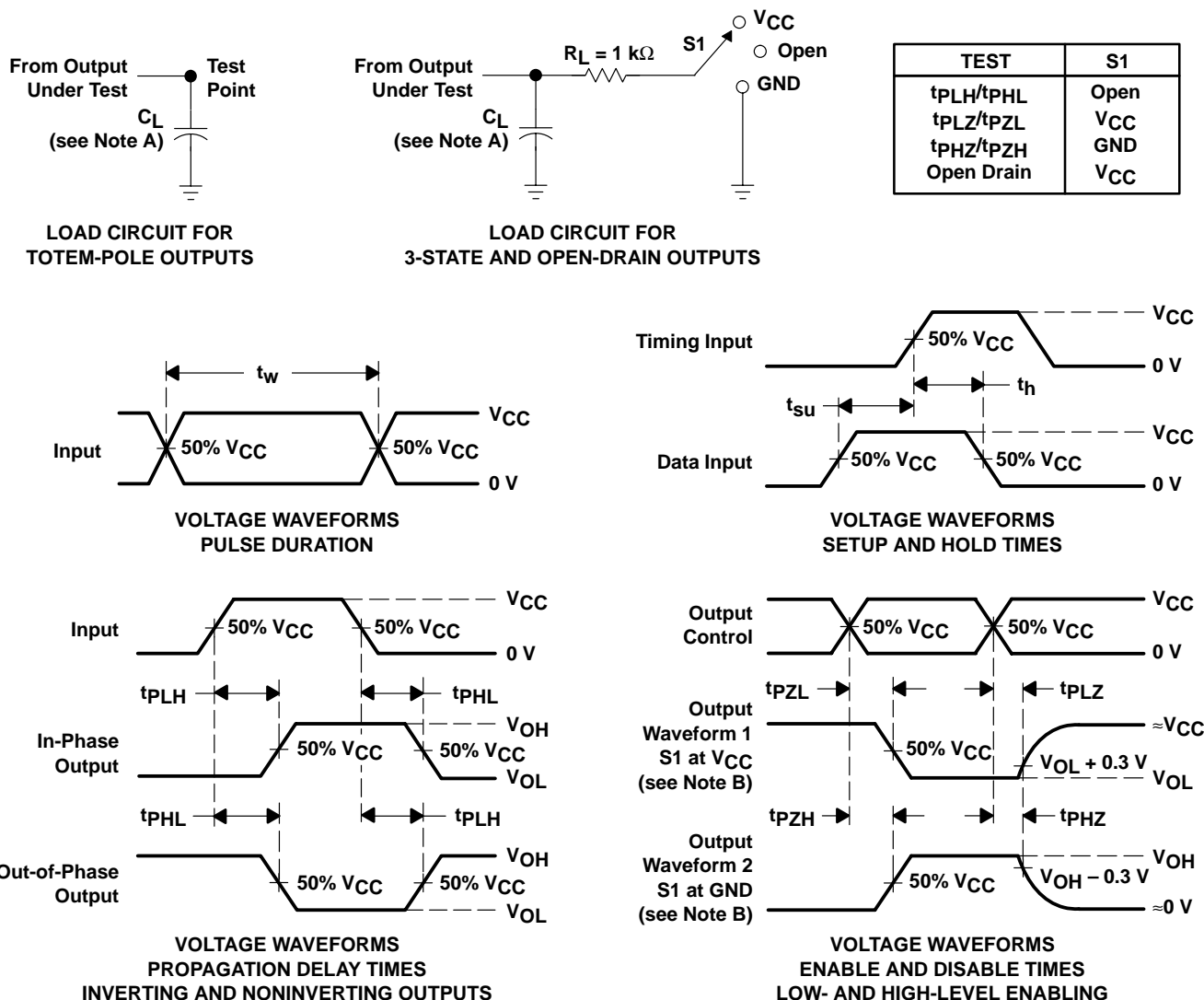
PARAMETER	TEST CONDITIONS	TYP	UNIT
$C_{pd}$ Power dissipation capacitance	No load, $f = 1\text{ MHz}$	14	pF



# SN54AHC245, SN74AHC245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9681801Q2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9681801QRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9681801QSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9681801VRA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9681801VSA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SN74AHC245DBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI
SN74AHC245DBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DBRE4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DGVR	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DGVRE4	ACTIVE	TVSOP	DGV	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AHC245NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AHC245NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245PW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245PWE4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245PWLE	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI
SN74AHC245PWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245PWRE4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AHC245PWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54AHC245FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54AHC245J	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54AHC245W	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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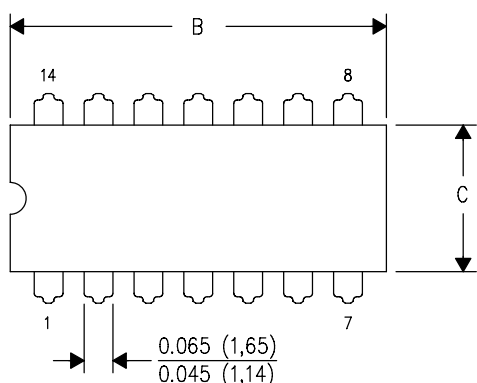
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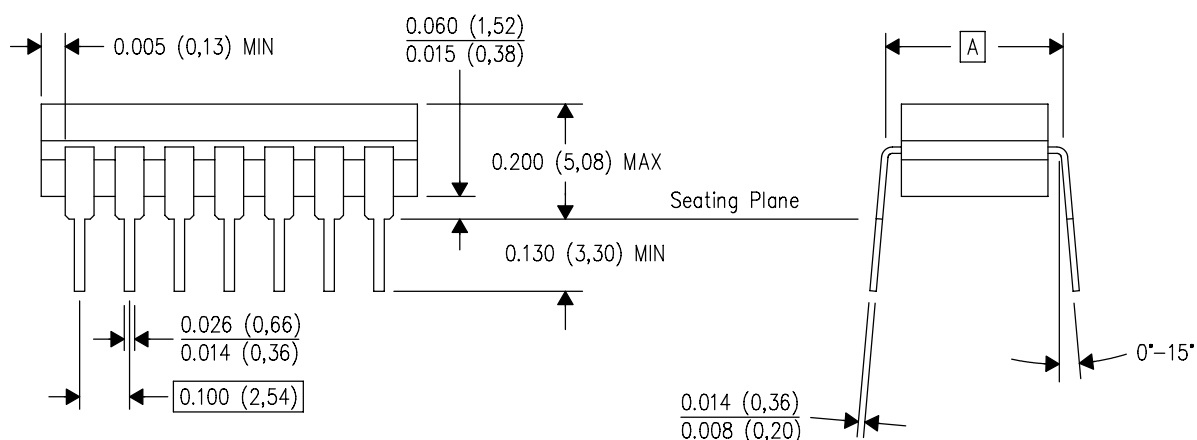
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

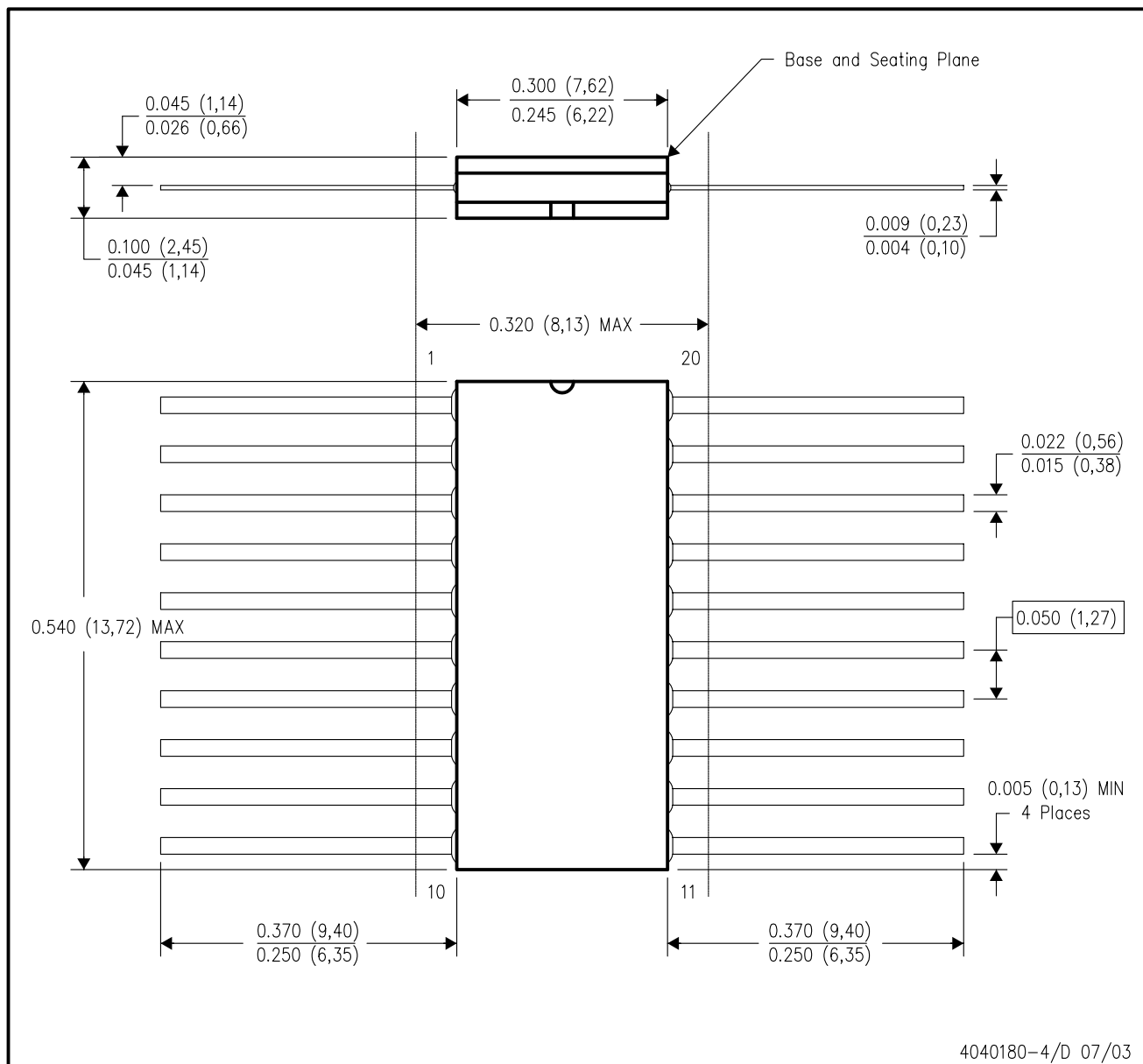


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within Mil-Std 1835 GDFP2-F20

28 TERMINAL SHOWN

- The technical drawing shows a square component with a central square hole. The outer square has a side length of 25 mm. The inner square hole has a side length of 18 mm. The distance from the center of the hole to the outer edge is 12.5 mm. The component has 25 terminals, numbered 1 to 25, arranged in a square pattern around the hole. The terminals are located at the corners and midpoints of the sides. The dimensions are given in millimeters (mm) and inches (in).

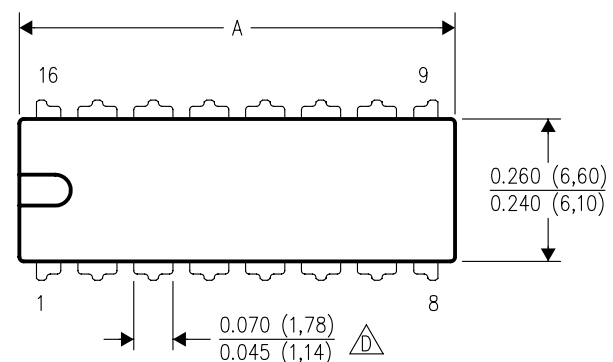
NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

The drawing also includes detailed dimensions for the terminals and the central hole. The terminal pitch is 0.020 mm (0,51) and 0.010 mm (0,25). The terminal width is 0.055 mm (1,40) and 0.045 mm (1,14). The terminal height is 0.028 mm (0,71) and 0.022 mm (0,54). The terminal spacing is 0.050 mm (1,27). The terminal thickness is 0.080 mm (2,03) and 0.064 mm (1,63). The terminal length is 0.045 mm (1,14) and 0.035 mm (0,89).

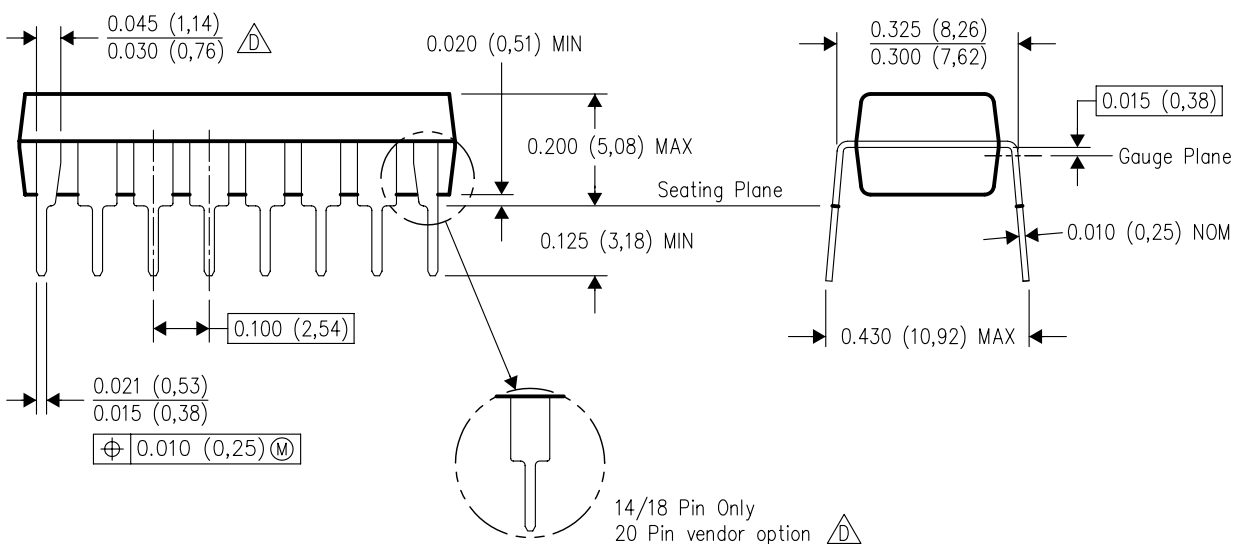
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE





PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

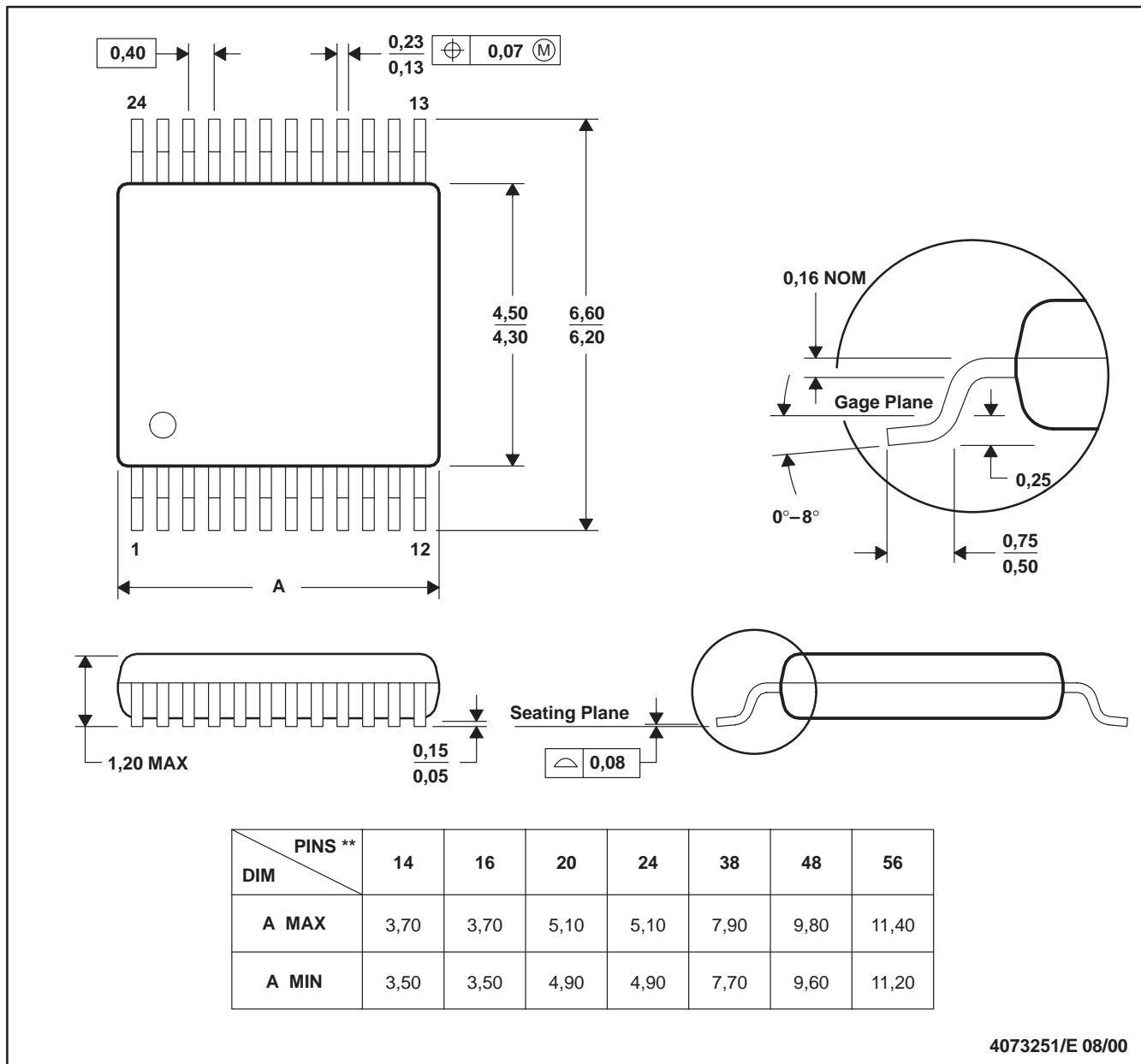
NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

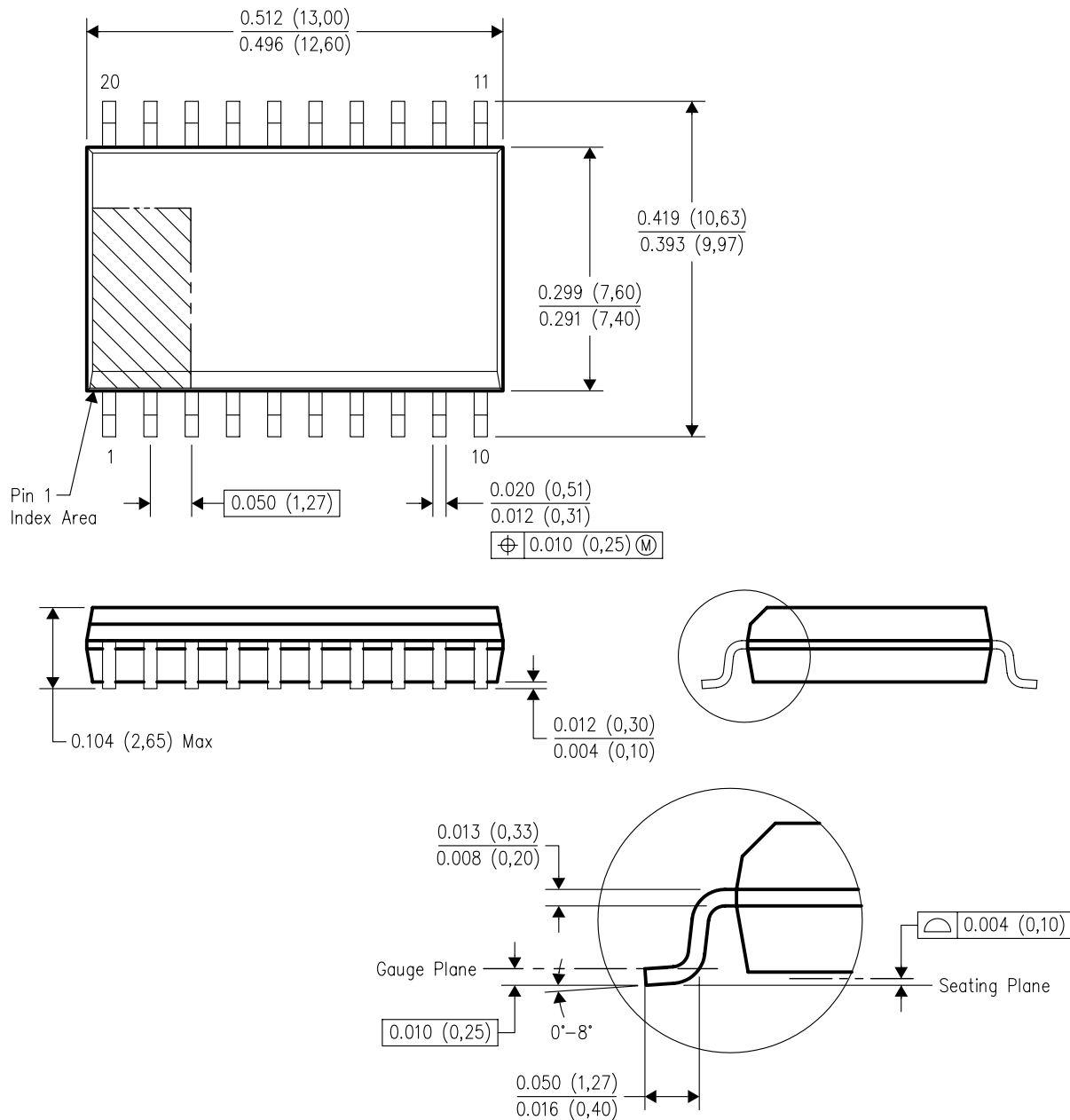
24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



4040000-4/F 06/2004

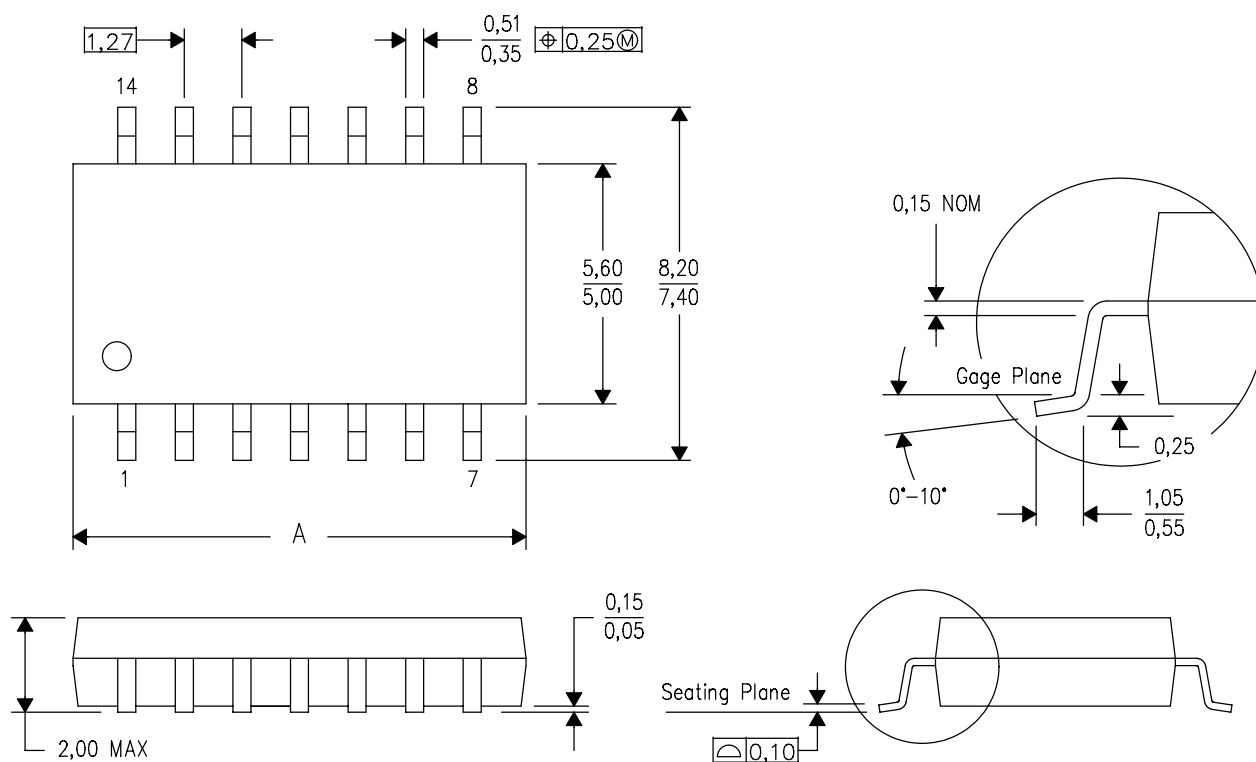
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AC.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

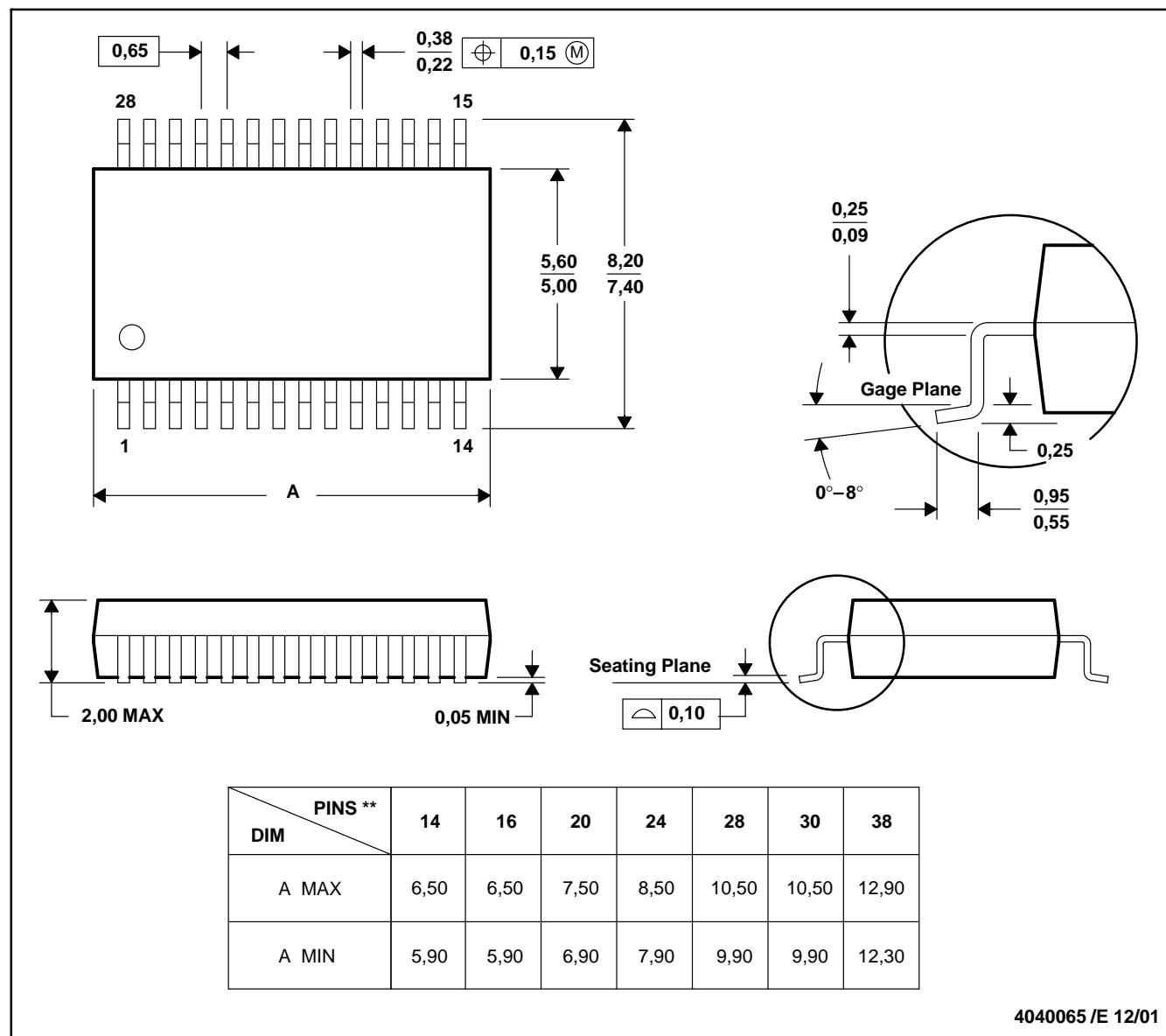
4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



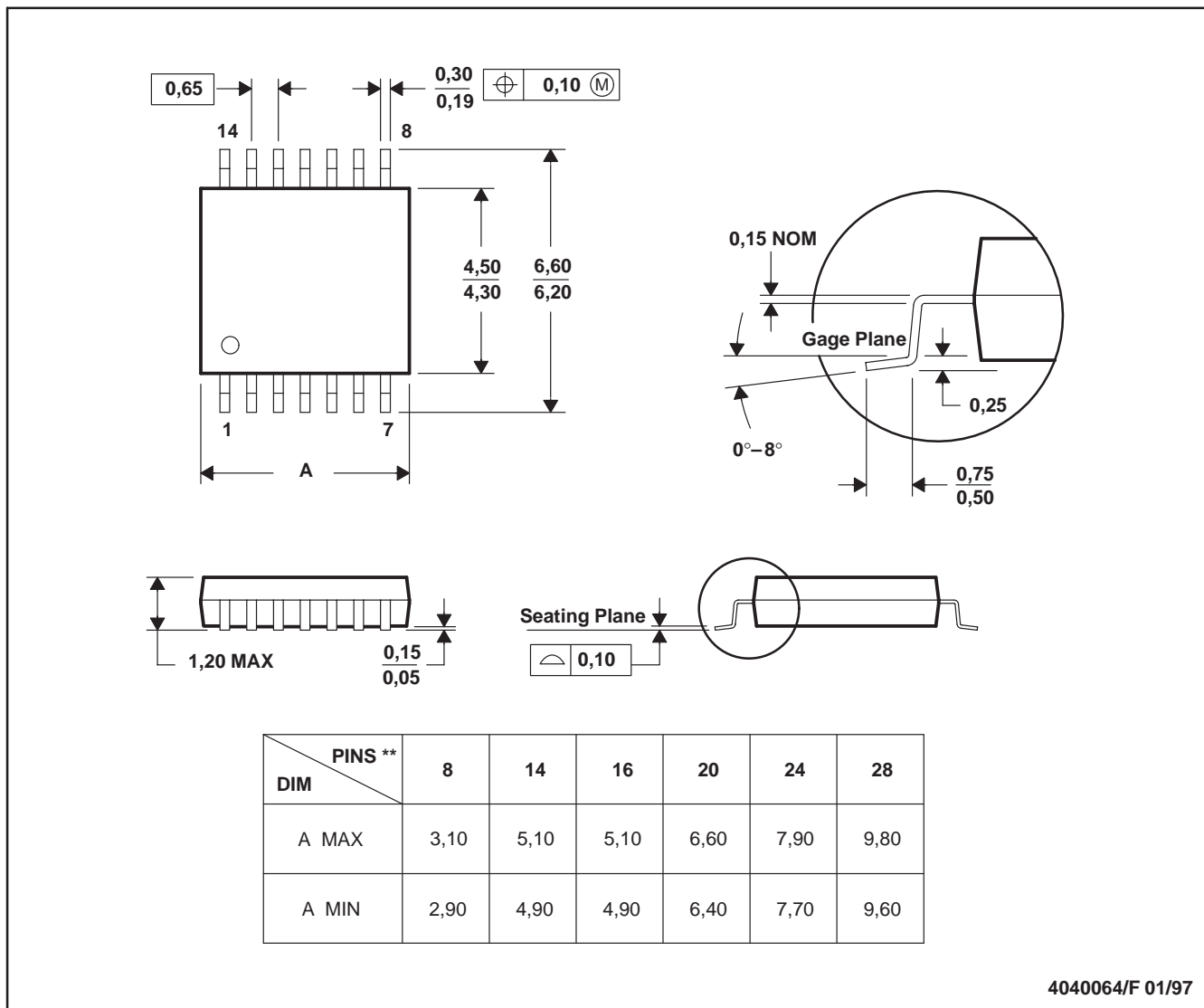
- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150



## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
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